RoHS

HALOGEN FREE

GREEN

(5-2008)

### Vishay Dale Thin Film

## ThermaWick® Thermal Jumper Surface Mount Chip



#### **LINKS TO ADDITIONAL RESOURCES**







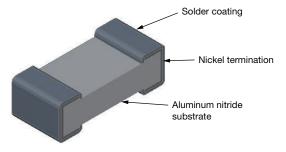






THJP surface-mount chips are designed to provide an electrically isolated thermal conductive pathway to a ground plane or heat sink while maintaining the electrical isolation of the device. The devices are constructed with aluminum nitride substrates in both SnPb and Pb-free wraparound termination styles. The low capacitance of the device makes them an excellent choice for high frequency and thermal ladder applications. Custom sizes available.

#### CONSTRUCTION



#### **FEATURES**

- Electrically isolated thermal conductor
- High thermal conductivity AIN substrate (170 W/mK)
- Electrically isolated terminations (> 999 MΩ)
- Low capacitance
- Available with SnPb or lead (Pb)-free wrap terminations
- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **APPLICATIONS**

- · Power supplies and converters
- RF amplifiers
- Synthesizers
- Switch mode power supplies
- · Pin and laser diodes
- Filters

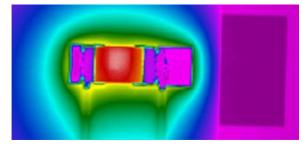
# FUNCTIONAL APPLICATIONS / CONNECTION OPTIONS

- Component to heat sink
- · Component to case
- · Component to ground plane
- Pad to pad
- Pad to via
- Pad to trace

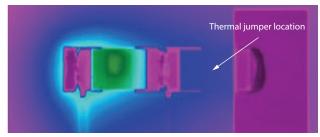
#### **HEAT TRANSFER DEMONSTRATION**

Chip surface temperature was measured using a FLIR SC645 thermal imaging system under ambient conditions. The devices were mounted to an FR4 test card designed with a 25 mm x 19 mm copper heat sink. Power was supplied to device to cause the surface temperature to stabilize at 150 °C. The device was then retested at the same power level with the thermal jumper connecting the device to the heat sink.

#### Example THJP 1206 Thermal Jumper Showing 54.3 °C Surface Temperature Reduction



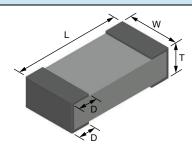
Ceramic Resistor Chip Without Thermal Jumper (149.8 °C)



Ceramic Chip Resistor With Thermal Jumper (95.5 °C)

## Vishay Dale Thin Film





CASE SIZE	L	W	Т	D	WEIGHT (g)
0603	0.061 ± 0.005	$0.033 \pm 0.005$	$0.030 \pm 0.005$	0.015 ± 0.005	0.003
0612	$0.063 \pm 0.005$	0.126 ± 0.005	$0.030 \pm 0.005$	0.015 ± 0.005	0.013
0805	0.079 ± 0.005	0.047 ± 0.005	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.006
1206	0.126 ± 0.005	$0.063 \pm 0.005$	$0.030 \pm 0.005$	0.020 ± 0.005	0.013
1225	0.126 ± 0.005	0.252 ± 0.005	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.052
2512	0.252 ± 0.005	0.126 ± 0.005	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.052

TYPICAL CHARACTERISTICS						
CASE SIZE	0603	0612	0805	1206	1225	2512
Thermal resistance (°C/W), T <sub>R</sub>	14	4	13	15	4	15
Thermal conductance (mW/°C), T <sub>C</sub>	70	259	77	65	259	65
Capacitance (pF)	0.07	0.26	0.15	0.07	0.26	0.07
Dielectric withstanding voltage kV <sub>AC</sub> , RMS (60 Hz)	> 1.5	> 1.5	> 1.5	> 2.5	> 1.5	> 3.5

#### Note

• 
$$T_R = \frac{L}{k (T \cdot W)}$$

where k is the thermal conductivity of AIN, 170 W/mK

$$T_C = \frac{1}{T_R}$$

STANDARD ELECTRICAL SPECIFICATIONS	
TEST	SPECIFICATIONS
Operating temperature range	-65 °C to +150 °C
Storage temperature range	-65 °C to +150 °C

STANDARD MATERIAL SPECIFICATIONS	
Substrate material	Aluminum nitride (170 W/mK)
Termination (tin / lead)	Electroplate tin / lead over electroplate nickel
Termination (lead (Pb)-free)	Electroplate tin (e3) over electroplate nickel

ENVIRONMENTAL TESTS (Vishay Performance vs. MIL-PRF-55342 / AEC-Q200 Requirements)				
ENVIRONMENTAL TEST	CONDITIONS	LIMITS	TYPICAL VISHAY PERFORMANCE	
Solderability Visual	J-STD-002, method B and B1	95 %	Acceptable	
Solder mounting integrity Visual	MIL-PRF-55342, method par. 4.8.13.1	Pass / fail	Pass	
Board flex Visual	AEC-Q200, method 005	Pass / fail	Pass	





www.vishay.com

## Vishay Dale Thin Film

New Global Part Numbering: THJP1206AST1  T H J P 1 2 0 6 A S T 1
GLOBAL MODEL THJP  CASE SIZE THICKNESS A = 0.030"  TERMINATION B = wraparound Sn/Pb solder with nickel termination S = wraparound Sn (e3) solder with nickel termination RoHS compliant  TAPE AND REEL TO = 100 min., 100 mult. T1 = 1000 min., 1000 mult. T5 = 500 min., 300 mult. TF = full reel TS = 100 min., 1 mult. TI = 100 min., 1 mult. TI = 100 min., 1 mult. TI = 100 min., 1 mult. TF = 100 min., 1 mult. The single lot date code) TP = 100 min., 1 mult. The single lot date code) TP = 100 min., 1 mult. The single lot date code)



### **Legal Disclaimer Notice**

Vishay

### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.